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More than Moore or More Moore: a SWOT analysis



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More Moore v More than Moore

- Europeans popularized in 2000's

 Sound bites "No Exponential is Forever"
 In 90's Moore expressed doubts
- MM: who knows when it will end
- MtM: a new ontology for semiconductors
 The new reality after MM?
 - A new business model



Moore's Law Refresher

- A doubling of components
 - in a year (1965, modified to 2 years in 1975)
 - for roughly the same manufacturing cost
 - due to lithographic shrinking
 - Shrinkonomics
 - 1st work in Innovation Economics

Moore's clock

of economic innovation:

- How long it takes to
 - halve the cost
 - in a measure of user value
 - with a known innovation vector



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Strengths of More Moore

- Declining Cost per Function
 - Made possible by steady innovation
 - Self-fulfilling prophesy
- Bryant's corollary
 - Need less capacity = free fabs
- Social feedback loop
 - drives technologists & financiers
 - Success with each node reinforces the effort
 - Resources far larger than More Than Moore



Moore's Law and the value of Shrinkonomics



Moore's Law Drives Consumption



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Moore's Wall is the poor vision of many a prophet

- 1968: End of Optical Lithography seen as bringing ML to a close, with multiple follow-on's throughout the 70s, 80s, and 90s, until people tired of the *death of optical* argument
- 1993: Even Moore loses faith with No Exponential is Forever VMIC speech
- 1996: my 1st Scientific American article published, with the commission to address growing questions about Moore's Wall.
 - the answer: Failure Mode would be Economics, not technology and not expected any time soon
 - same answer in a follow-up article in 2004
- 2003: *But, Forever can be Delayed* Moore at ISSCC



Weaknesses 2004: The R&D Crisis

First given at ISMI Manufacturing Week



2010: The R&D Crisis Averted

First given at ISS 2010



32 nm brought to production with only a 2.2% rise in R&D cost Proof that Coopetition & Consolidation Work

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Weakness But...Moore's Law has not driven a Revenue Growth Difference



Moore's Law Driven =

- NAND
- DRAM
- MPU

Moore's Law Laggards =

everything else

The reason?

- Most Moore's Law Gains are Given Up in Price
 - DRAM -12%
 - NAND -16%
 - MPU -1%
 - Average -3%

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Threat: Keeping Moore's Law on track will be a Bigger Challenge in this Decade

Capital Productivity: The Lithography Metric



Opportunity Litho often stalls with new generations Hence the need for new wafer sizes





Opportunity The New Era of Materials

- 1G: Copper, Capacitor HiK TaO2, Ru
- 2G: LoK & Strain ... Ge
- **3G**: HiKMGHf_xO_x
- 4G: III-V, III-IV, Ge, Ga, GaN, TiO₂
- Drivers: Nanochips
 - device physics a new game <100nm</p>
 - power for battery life & mobility
 - power for fewer losses in transmission
 - Power chips for green tech

Opportunity

Why Care About Moore's Law?

- Price is a Critical Demand Driver
- without Shrinks . . .
 - few reasons for New Designs
- Moore's Law Laggards are pulled along by Moore's Law Leaders Fear of the Unknown
- Electronics last for far longer than
 - we replace them
 - growth could dwindle to nothing
 - especially with technostress
 - a demand killer
 - consumer electronics slowing
 - going to dentist preferred over buying a cell phone
- Without Moore's Law there won't be New & Improved Supply Push





Besides . . .

We Didn't Stop Using Cars

when manufacturing costs started to rise, though there are more horses alive today



Moore's Clock for Autos was 2.5 years



just imagine . . .

Where would **We** be without semiconductors?

More than Moore ... or Is there life after Moore's Law?







More than Moore Strengths

- Term popularized by Europeans in the last decade
- Sound bite: a new offshoot in semiconductor technology
 - extend the benefits of Moore's Law without scaling
 - Advanced packaging
 - Create entirely new value chains using the same technology developed for Moore's Law
- 3D Packaging
- EST: Emergent Semiconductor Technologies
 - MEMS: Micro-Electro-Mechanical-Systems
 - Solid State Lighting
 - PV Solar Cells



3D Packaging: Most Common Form of MtM thinking

- Volume mostly in wire bonded stacked die
 - An evolution of 2D Hybrid/SiP
 - Kilby's IC
- TSV is mostly in cell phone camera units
 - Complex = Costly
 - Lot's of promise
 - In the Hype Cycle since the nineties











http://electronics.wesrch.com/paper-details/pdf-EL1SE1UN1LORM-2-5d-3d-tsvc-coming-of-age http://www.chiphistory.org/



EST: Emergent Semiconductor Technologies

- The use of Semiconductor Manufacturing Technology to create new markets:
 - MEMS: Micro-Electro-Mechanical-Systems
 - Micromachines in Japan and Micro-Systems Technology in Europe
 - MOEMS: Micro-Opto-Electro-Mechanical-Systems
 - Nanobots/machines
 - LED Lighting and Displays
 - Solar PV
- Why Semiconductors?
 - Established tool & material supply base
 - Easy to machine and alter electrical & optical properties
 - Performs well under many different forces
- Small, high growth application focused markets

EST: MEMS









APM inkjet head



SOI

Cavity Platform Piezoresistive Accelerometer Platform



Doug Sparks http://electronics.wesrch.com/pdfEL1SE1EZDLFIS



Implantable pressure sensor





Jerwei Hsieh

http://electronics.wesrch.com/pdfEL1SE1EZDXVWL

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Strength: Vibrant Market

- MEMS have real applications
- Critical to all cell phones and tablets
- Critical to Autos



Source - iSuppli Corporation Teardown Analysis - Motorola Droid Mobile Handset



nttp://electronics.wesrch.com/paper-details/pdf-EL1SE1EZDIKMX-

mems-back-to-double-digit-growth

Weakness: lots of science fiction in the science

Nanobots in Development

– Medicine

- Cancer chemotactic sensors
 - Drug Delivery
 - Cell repair

– Energy

Oil extraction nanosponges
Oil spill clean up
Solar power efficiency
Ozone layer

- Detection and Defense

- Space exploration
 Military Defense
- Chemical Warfare Detection
- nanosensors detect <10 ppb

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http://scienceblogs.com/framing-science/NanotechFly.jpg

Lindsey Armstrong, Christopher Arnold, Kamal Banjara, Ahmad Al-douah http://electronics.wesrch.com/pdfEL1SE1EZDTSWO

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But today's science fiction is often tomorrow's science

Research Programs					
The main medical foci of the research programs in our lab are cancer, rigenerative medicine, cardiovascular medicine and infectious diseases.					
Multi-Stage Drug Delivery System	Proteomic NanoChips	Fracture Putty			
	Biochemical surfaces inducid, DNA, enzyme countrol (arge pore) Chemical surfaces (hydrophobic, iong) Chemical surfaces (hydrophobic, iong) (hydrophobic, iong)				

http://medical.wesrch.com/paper-details/pdf-ME14GWMAWTHJM-nanochipresearch-in-medicine-for-cancer-rigenerative-cardiovascular-and-infectious-diseases

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Where Technology = Specifurly

But today's science fiction is often tomorrow's science



EST: LED Lighting



Rubicon Technology Sapphire







Philips Lumileds







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Threats: LED Pricing

- LED prices have flatlined
 - <\$200/Klm
 - 60W Equivalent
- CFL
 - < \$6/KIm
- Incandescent
 - < \$2/KIm
- Not competitive at the consumer level
- Competitive at Enterprise level
 - Maintenance, Power & Security
- Opportunity for Major Breakthroughs



PV Solar Pricing

- PV Solar prices will soon break through \$3W grid-parity barrier.
- PV solar panel prices have dropped 4.6% since beginning of the year
- Currently running at a 3-year Moore's Law rate
 - It's been accelerating





Opportunity MtM EST Markets

	2010 Size \$B	Growth Potential	Comments
Solar PV	20.4	25-30%	Politically driven. BP disaster will help. Still relies on subsidy
MEMS	7.4	5-20%	1 st Gen Mature 2 nd Gen growth>40%
LED Lighting	6.2	30-40%	Power plant capital requirements are the driver
Nanobots	?	Huge	Medical and Military Apps are the Driver

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Appendix: Web sites

VLSIresearch.com

- VLSI's market research page
- For research on the semiconductor supply chain

ChipHistory.org

- Education site on semiconductors
- Virtual history museum
- Based on industry donations

weSRCH.com

- Where Technology = Opportunity
- A virtual science & engineering conference
- Ads reach 200K visitors per month
 - 15-20mins & 35 page views / visit, >1 visit / week
 - High signature authority and income viewership
 - High Yield on Targets for your business

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